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TITLE: SENSOR UNIBODY 6 I/O	DOCUMENT NO: 98ASB42793B	REV: R
	STANDARD: NON-JEDEC	
	SOT1877-1	24 JUL 2017



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION -A- IS INCLUSIVE OF THE MOLD STOP RING. MOLD STOP RING NOT TO EXCEED 16.00 (0.630).

STYLE 1:
 PIN 1. VOUT
 2. GROUND
 3. VCC
 4. V1
 5. V2
 6. VEX

STYLE 2:
 PIN 1. OPEN
 2. GROUND
 3. -VOUT
 4. VSUPPLY
 5. +VOUT
 6. OPEN

STYLE 3:
 PIN 1. OPEN
 2. GROUND
 3. +VOUT
 4. +VSUPPLY
 5. -VOUT
 6. OPEN

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.595	0.630	15.11	16.00
B	0.514	0.534	13.06	13.56
C	0.200	0.220	5.08	5.59
D	0.027	0.033	0.68	0.84
F	0.048	0.064	1.22	1.63
G	0.100	BSC	2.54	BSC
J	0.014	0.016	0.36	0.40
L	0.695	0.725	17.65	18.42
M	30° NOM		30° NOM	
N	0.475	0.495	12.07	12.57
R	0.430	0.450	10.92	11.43
S	0.090	0.105	2.29	2.66

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